

Pb Free Plating Product

M1 thru M7



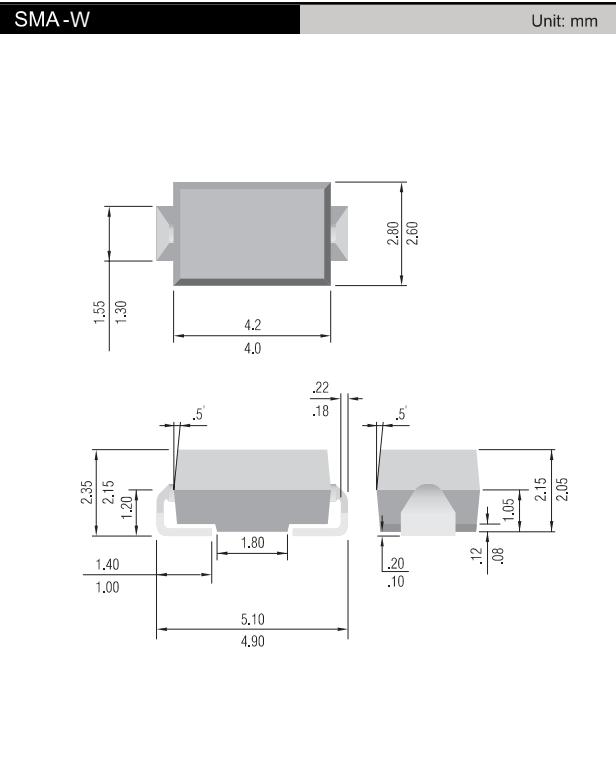
1.0 AMP SURFACE MOUNT GENERAL PURPOSE RECTIFIERS

Features

- For surface mounted applications
- Low profile package
- Built-in strain relief
- Easy pick and place
- Plastic package has Underwriters Laboratory Flammability Classification 94V-0
- High temperature soldering:
260°C/10 seconds at terminals

Mechanical Data

- **Case:** SMA-W molded plastic
- **Terminals:** Solder plated, solderable per MIL-STD-750, method 2026
- **Polarity:** Indicated by cathode band
- **Weight:** 0.004 ounce, 0.115 gram

**Absolute Maximum Ratings and Characteristics**

Ratings at 25°C ambient temperature unless otherwise specified. Single phase, half wave, 60Hz, resistive or inductive load. For capacitive load, derate current by 20%.

	Symbols	M1	M2	M3	M4	M5	M6	M7	Units
Maximum repetitive peak reverse voltage	V _{RRM}	50	100	200	400	600	800	1000	Volts
Maximum RMS voltage	V _{RMS}	35	70	140	280	420	560	700	Volts
Maximum DC blocking voltage	V _{DC}	50	100	200	400	600	800	1000	Volts
Maximum average forward rectified current at T _L = 100°C	I _(AV)				1				Amp
Peak forward surge current 8.3ms single half sine-wave superimposed on rated load (MIL-STD-750D 4066 method)	I _{FSM}				30				Amps
Maximum instantaneous forward voltage at 1A	V _F				1.1				Volts
Maximum DC reverse current T _A = 25°C at rated DC blocking voltage T _A = 125°C	I _R				5				µA
Maximum reverse recovery time (Note 1)	T _{rr}				200				
Typical junction capacitance (Note 2)	C _J				2				µS
Maximum thermal resistance (Note 3)	R _{θJL}				15				pF
Operating and storage temperature range	T _J , T _S				30				°C/W
					-50 to + 150				°C

Notes: (1) Reverse recovery test conditions: I_F = 0.5A, I_R = 1A, I_{rr} = 0.25A

(2) Measured at 1MHz and applied reverse voltage of 4volts

(3) 8mm² (0.013mm thick) land areas

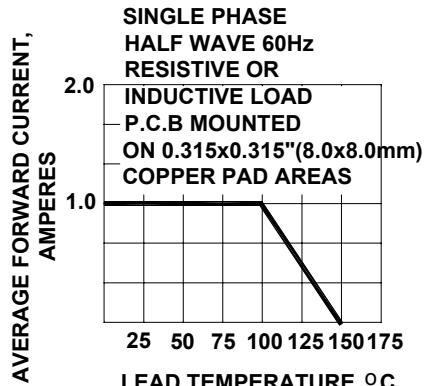


Fig. 1-FORWARD CURRENT DERATING CURVE

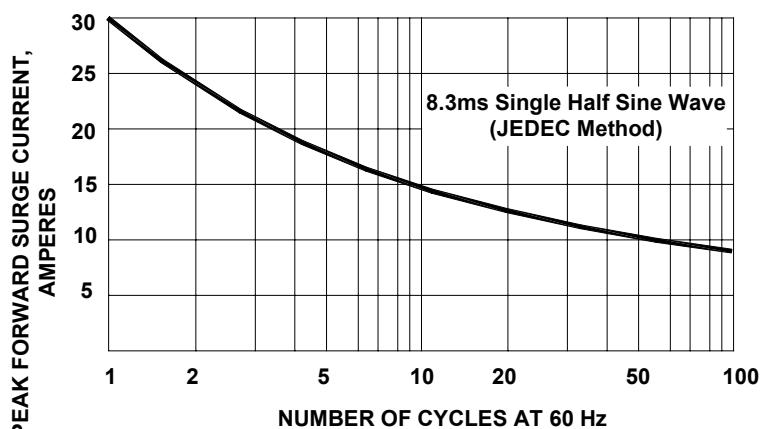


Fig. 2-MAXIMUM NON-REPETITIVE PEAK FORWARD SURGE CURRENT

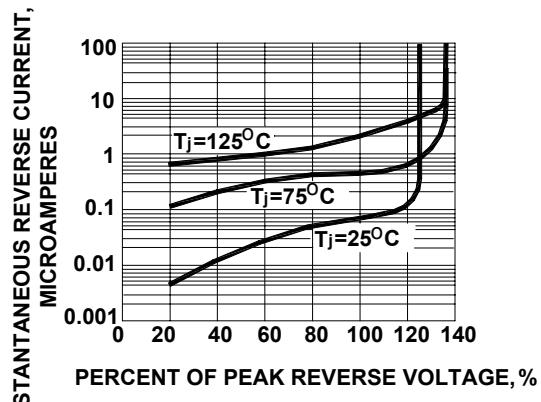


Fig. 3-TYPICAL REVERSE CHARACTERISTICS

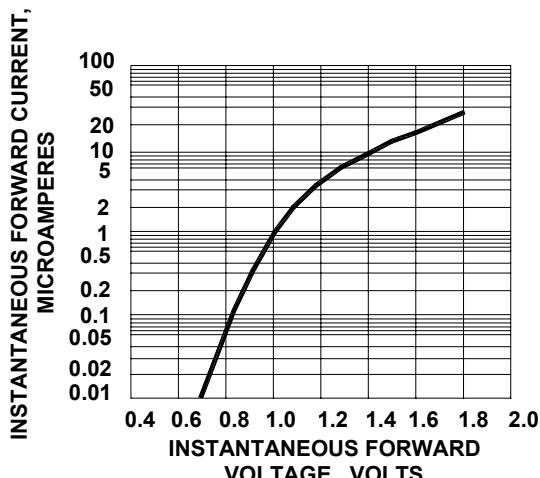


Fig. 4-TYPICAL INSTANTANEOUS FORWARD CHARACTERISTICS

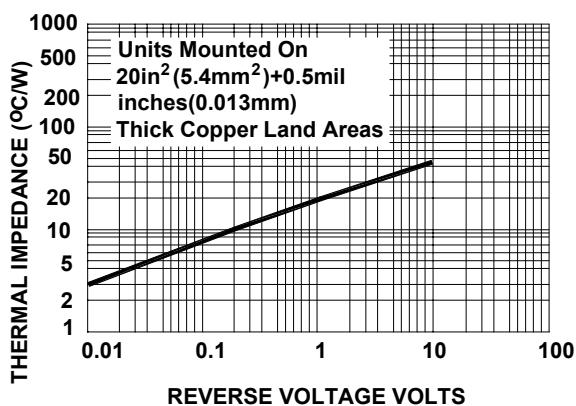


Fig. 5-TRANSIENT THERMAL IMPEDANCE

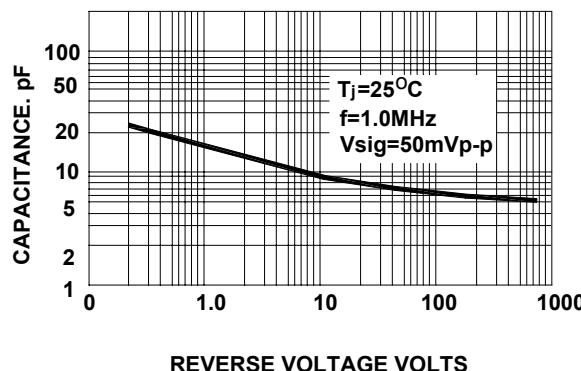


Fig. 6-TYPICAL JUNCTION CAPACITANCE